

# SANYO Semiconductors DATA SHEET

# 2SK1459LS — Ultrahigh-Speed Switching Applications

## **Features**

- · Low ON-resistance, ultrahigh-speed switching.
- · Attachment workability is good by Mica-less package.

# **Specifications**

### Absolute Maximum Ratings at Ta=25°C

Parameter	Symbol	Conditions	Ratings	Unit
Drain-to-Source Voltage	VDSS		900	٧
Gate-to-Source Voltage	VGSS		±30	V
Drain Current (DC)	ID		2.5	Α
Drain Current (Pulse)	IDP	PW≤10μs, duty cycle≤1%	5	Α
Allowable Power Dissipation	PD		2.0	W
	"	Tc=25°C	30	W
Channel Temperature	Tch		150	°C
Storage Temperature	Tstg		-55 to +150	°C

#### Electrical Characteristics at Ta=25°C

Parameter	Symbol	Conditions	Ratings			Unit
			min	typ	max	Offic
Drain-to-Source Breakdown Voltage	V(BR)DSS	ID=1mA, VGS=0V	900			V
Zero-Gate Voltage Drain Current	IDSS	V <sub>DS</sub> =900V, V <sub>GS</sub> =0V			1.0	mA
Gate-to-Source Leakage Current	IGSS	V <sub>GS</sub> =±30V, V <sub>DS</sub> =0V			±100	nA
Cutoff Voltage	VGS(off)	VDS=10V, ID=1mA	2.0		3.0	V
Forward Transfer Admittance	yfs	V <sub>DS</sub> =20V, I <sub>D</sub> =1.5A	0.8	1.5		S
Static Drain-to-Source On-State Resistance	R <sub>DS</sub> (on)	I <sub>D</sub> =1.5A, V <sub>GS</sub> =10V		4.7	6.0	Ω
Input Capacitance	Ciss	V <sub>DS</sub> =20V, f=1MHz		350		pF
Output Capacitance	Coss	V <sub>DS</sub> =20V, f=1MHz		150		pF
Reverse Transfer Capacitance	Crss	V <sub>DS</sub> =20V, f=1MHz		100		pF
Turn-ON Delay Time	td(on)	I <sub>D</sub> =1.5A, V <sub>G</sub> S=10V, V <sub>D</sub> D=200V, R <sub>G</sub> S=50Ω		15		ns
Rise Time	t <sub>r</sub>	I <sub>D</sub> =1.5A, V <sub>G</sub> S=10V, V <sub>DD</sub> =200V, R <sub>G</sub> S=50Ω		25		ns
Turn-OFF Delay Time	t <sub>d</sub> (off)	I <sub>D</sub> =1.5A, V <sub>G</sub> S=10V, V <sub>D</sub> D=200V, R <sub>G</sub> S=50Ω		120		ns
Fall Time	tf	I <sub>D</sub> =1.5A, V <sub>GS</sub> =10V, V <sub>DD</sub> =200V, R <sub>GS</sub> =50Ω		40		ns
Diode Forward Voltage	V <sub>SD</sub>	I <sub>S</sub> =2.5A, V <sub>GS</sub> =0V			1.8	V

(Note) Be careful in handling the 2SK1459LS because it has no protection diode between gate and source.

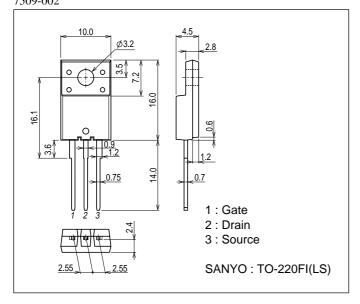
Marking: K1459

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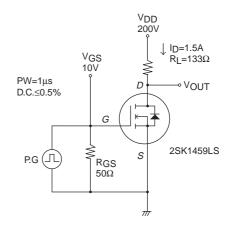
# **SANYO Semiconductor Co., Ltd.**

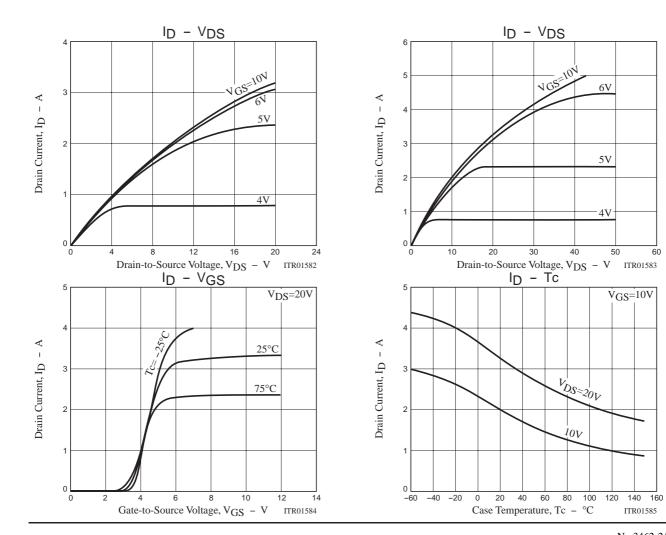
# **Package Dimensions**

unit: mm (typ) 7509-002



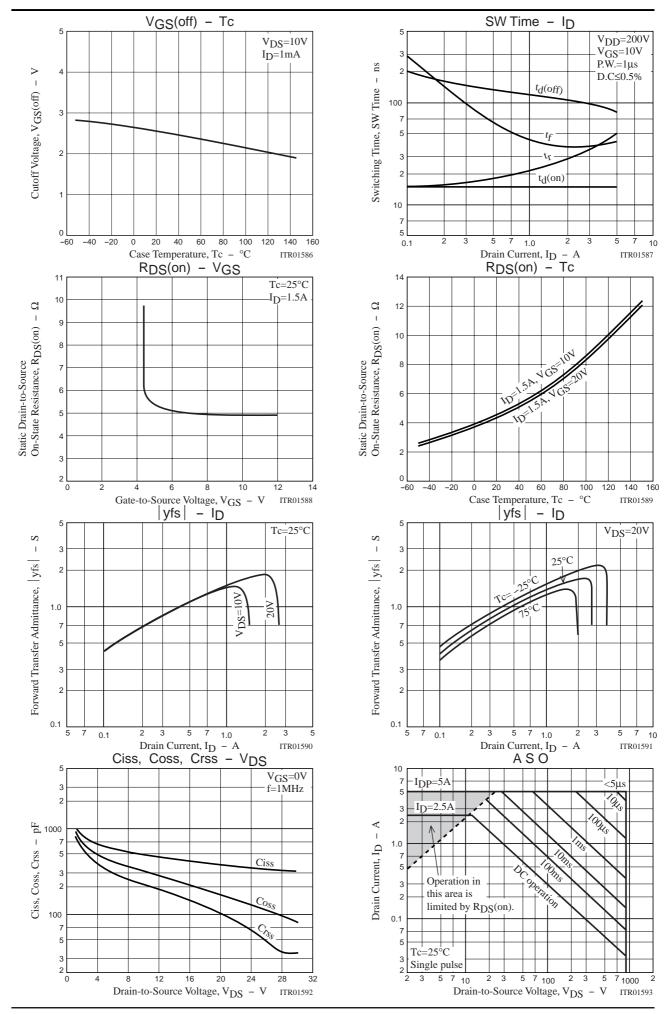
# **Switching Time Test Circuit**



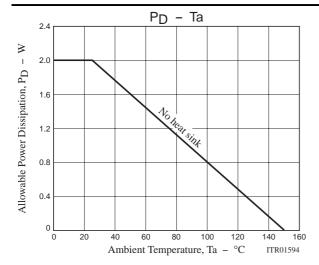


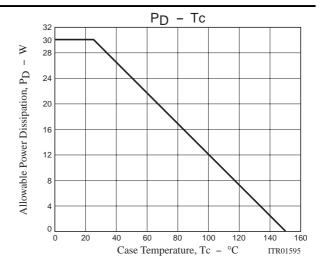
ITR01585

V<sub>GS</sub>=10V



#### 2SK1459LS





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